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YOUR MODULE NO.:	OUR MODULE NO.:	K350QVG-V2-F

YOUR SPEC NO.:		OUR FULL SPEC NO.:	FS-K350Q	VG-V2-F-03
	•			

Remark:

K350QVG-V2-F is fully compatible with **K350QVG-V1-F** and can be used to replace the K350QVG-V1-F (K350QVG-V1-F already phased out as the EOL of tft cell.), no need to changing software and hardware. (Already approved by TI on Stellaris M3 Evaluation board.)

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K350QVG-V2-F

Product

Standard LCD Module 320 x RGB x 240 Dots 3.5" 262K colors TFT display Wide temperature With white LED backlight With Touch Panel

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DOCUMENT	DATE	DESCRIPTION	PREPARED	APPROVEI
REVISION			BY	BY
01	2008.04.28	First Release.	MF Zou	
02	2010.06.30	Revised typing error Update packing reference	MF Zou	
03	2010.07.15	Update packing reference	MF Zou	

2. General Description

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- 3.5"(diagonal), 320 x RGB x 240 dots, 262K colors, Transmissive, TFT LCD module.
- Viewing Direction: 12 o'clock.

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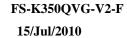
- Driving IC: SSD2119 or equivalent TFT controller/driver.
- 18-bits data bus (parallel RGB interface/8080 parallel system interface).
- With Touch Panel.
- With internal voltage booster.
- Logic voltage: 3.3V (typ.).

3. Mechanical Specifications

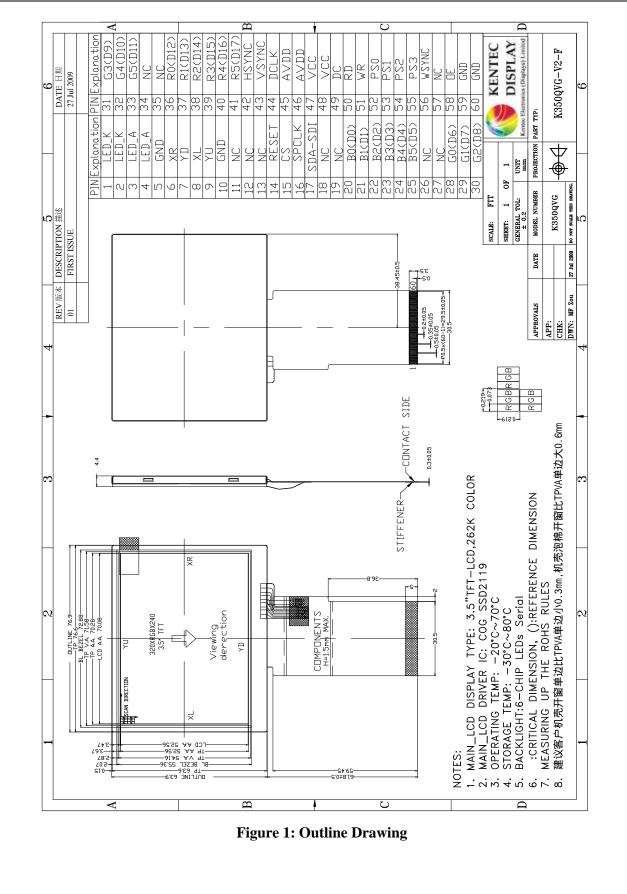
The mechanical detail is shown in Fig. 1 and summarized in Table 1 below.

Table 1 Parameter Specifications Unit 76.9(W) x 63.9(H) x 4.4(D) **Outline** dimensions mm (Exclude FPC, cables of backlight) View area 72.88(W) x 55.36(H) mm TP view area 71.58 (W) x 54.2(H) mm Color TFT LCD active area 70.08(W) x 52.56(H) mm 320xRGBx240 Display format 320 x RGB x 240 dots Color configuration **RGB** stripes -Dot size 0.219(RGB)(W) x 0.219(H) mm Weight ~40 grams





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4. Interface signals								
Table 2: Pin assignment								
Pin No.	Symbol		Description					
1-2	LED_K	П	1	с т <u>р</u>	D1 11	· · · · ·		
3-4	LED_A	Power	supply	IOP LE	D backl	light		
5	GND	Power	supply	(syster	n groun	d)		
6	XR							
7	YD	Termi	nal of to	uch na	nel			
8	XL			Juen pu				
9	YU							
10	GND		<u> </u>		n groun	d)		
11-13	NC		nnection					
14	RESET		n reset j					
15	CS	1	elect pi					
16	SPCLK		pin of s					
17	SDA-SDI		oin of se		erface			
18-19	NC		nnection					
20-25	B[0-5]				bi-dired	ctional (D0-D5)		
26-27	NC	No connection						
28-33	G[0-5]	Green data 6-bit/18bit bi-directional (D6-D11)						
34-35	NC	No connection						
36-41	R[0-5]	Red data 6-bit/18bit bi-directional (D12-D17)						
42	HSYNC	Line synchronization signal input						
43	VSYNC				nizatior	n signal input		
44	DCLK		ock sigi					
45-46	AVDD				d drivir	ıg		
47-48	VCC		y voltag		gic			
49	DC		el Interf					
50	RD					signal and reads data at the low level.		
51	WR					e signal and writes data at the rising edge.		
			ice seled	ction pi				
		PS3	PS2	PS1	PS0	Interface mode		
		0	0	1	0	16-bit 8080 parallel interface, D[17:10]&D[8:1]		
		0	0	1	1	8-bit 8080 parallel interface, D[8:1]		
		0	1	0	0	9-bit RGB(262 colour) + 3-wire SPI, D[8:0]		
52-55	PS[0:3]	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$						
		0	1	1	0	18-bit RGB(262K colour) + 3-wire SPI, D[17:0]		
		0	1	1	1	6-bit RGB(262K colour) + 3-wire SPI, D[8:3]		
		1	0	1	0	18-bit 8080 parallel interface, D[17:0]		
		1	0	1	1	9-bit 8080 parallel interface, D[8:0]		
		1	1	1	0	3-wire SPI		
56	WSYNC	Ram V	Vrite Sy	nchron	ization	output		
57	NC	No con	nnection	n				
58	OE	Displa	y enabl	e pin fr	om con	troller		
59-60	GND	Power	supply	(syster	n groun	d)		



5. Absolute Maximum Ratings

5.1 Electrical Maximum Ratings – for IC Only

Table 3: Electrical Maximum Ratings – for IC
--

Parameter	Symbol	Min.	Max.	Unit	Note
Supply voltage	VCC	-0.3	+4.0	V	1
Input voltage	AVDD	-0.3	+5.0	V	

Note:

1.VCC, GND must be maintained.

2. The modules may be destroyed if they are used beyond the absolute maximum ratings.

5.2 Environmental Condition

Table 4						
Item	tempera	Operating temperature (Topr)			Remark	
	Min.	Max.	Min. Max.			
Ambient temperature	-20°C	+70°C	-30°C	+80°C	Dry	
Humidity (Note 1)	80% max. RH for Ta $\leq 40^{\circ}$ CNo< 50% RH for 40°C < Ta \leq Maximum operating temperaturecondensation					

Note 1: Product cannot sustain at extreme storage conditions for long time.

6. Electrical Specifications

Typical Electrical Characteristics

At Ta = 25 °C, VCC=IOVCC= 3.3V, GND=0V.

<u>Table 5</u>							
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Supply voltage (logic)	VCC-GND		1.4	-	3.6	V	
Supply voltage (lcd driving)			2.5 or VDDIO	-	3.6	V	
	VGH		9	-	18.0	V	
Output voltage(LCD)	VGL		-15.0	-	-6	V	
	VCOM		-1	-	6	V	
Supply current (Logic & LCD)	ICC	VDD=3.3V	-	-	10	mA	
Supply voltage of white LED backlight	VLED	Forward current =20 mA	-	19.2	21.6	V	
Luminance (on the module surface)		Number of LED dies = 6	230	270	-	cd/m ²	



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7. Optical Characteristics

Table 7: Optical specifications								
Items		Symbol	Condition	Spe	ecificati	ons	Unit	
Items		Symbol	Condition	Min.	Тур.	Max.	Omt	
Contrast Ra	atio	CR		150	300	-	-	
Response T	ime	T _R		-	15	30	ms	
Response 1	me	$T_{\rm F}$		-	35	50	ms	
	Red	X _R		0.604	0.624	0.644	-	
	Reu	Y _R		0.302	0.322	0.342	-	
	Green	X_{G}		0.268	0.288	0.308	-	
Chromaticity		Y _G		0.540	0.560	0.580	-	Note
Cinomaticity	Blue	X _B		0.127	0.147	0.167	-	Note
	Diuc	Y _B		0.097	0.117	0.137	-	
	White	X_{W}		-	0.307	-	-	
	vv mite	Y_W		-	0.328	-	-	
	Hor.	<pre> \$\$\\$\\$</pre>		-	45	-		
Viewing angle		\$\$\\$	Center CR=10	-	45	-	deg.	
	Ver.	$\theta 2(12 \text{ o'clock})$		-	15	-		
	v e1.	$\theta 1(6 \text{ o'clock})$		-	35	-		
NTSC ratio					61.5		%	

Note 1: Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

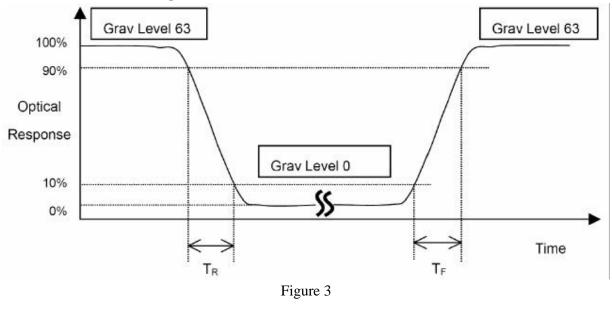
L63: Luminance of gray level 63

L0: Luminance of gray level 0

 $\mathbf{CR} = \mathbf{CR} \ (10)$

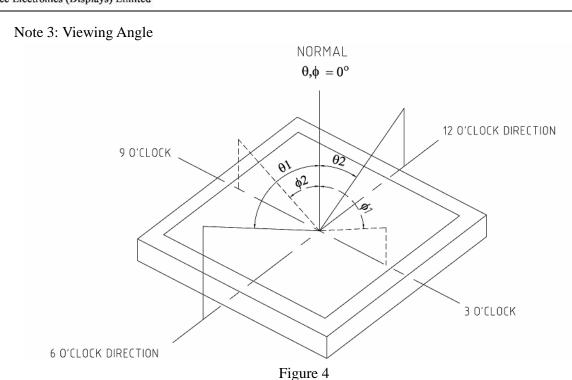
CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note 5.

Note 2: Definition of Response Time (TR, TF):





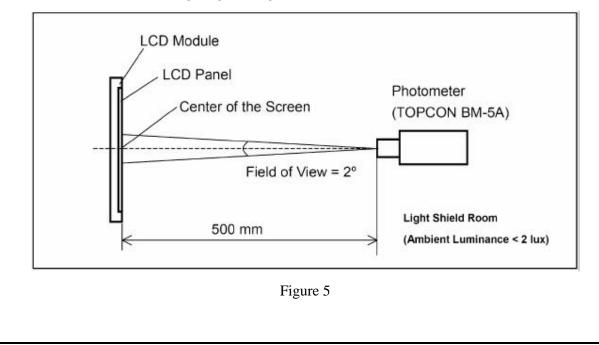
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The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 6 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

Note 4: Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.





8. AC Characteristics

Please refer SSD2119 datasheet.

9. Reliability Test Item

Test Item	Sample Type	Test Condition	Test result determinant gist
High temperature	Normal temperature	70±3 ;96H	the inspection of
storage	Wide temperature	80±3 ;96H	appearance and function
Low temperature	Normal temperature	-20±3 ;120H	character.
storage	Wide temperature	-30±3 ;120H	
High temperature	Normal temperature	50 ±3 ,90%±3%RH;96H	
/humidity storage	Wide temperature	60 ±3 ,90%±3%RH;96H	
High temperature	Normal temperature	60±3 ;96H	no objection of the function
operation	Wide temperature	70±3 ;96H	character; no fatal objection of
Low temperature	Normal temperature	0±3 ;96H	the appearance.
operation	Wide temperature	-20±3 ;96H	
High temperature	Normal temperature	40 ±3 ,90%±3%RH;96H	
/humidity operation	Wide temperature	50 ±3 ,90%±3%RH;96H	
Temperature Shock	Normal temperature	-20±3 ,30min? 70±3 ,30 min;10cycle	inspect the objections appearance、function & the whole structure
	Wide temperature	-30±3 ,30min 80±3,30min;10cycle	The inspection of appearance, function & the whole structure

10. Suggestions for using LCD modules

10.1 Handling of LCM

- 1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
- 2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
- 3. Don't apply excessive force on the surface of the LCM.
- 4. If the surface is contaminated ,clean it with soft cloth. If the LCM is severely contaminated , use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer . The following solvents is especially prohibited: water , ketone Aromatic solvents etc.
- 5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by

water droplets, moisture condensation or a current flow in a high-humidity environment.

6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

7. Don't disassemble the LCM.

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8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

9. Do not alter, modify or change the the shape of the tab on the metal frame.

- 10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- 11. Do not damage or modify the pattern writing on the printed circuit board.
- 12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
- 13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 14. Do not drop, bend or twist LCM.

10.2 Cautions for installing and assemabling if the module has Touch Panel

1. Use a buffer material (Gasket) between the touch panel and Front-case to protect damage and wrong operating. The dimension of the buffer material's edge between the TP V.A. edge is Min. 0.3mm.

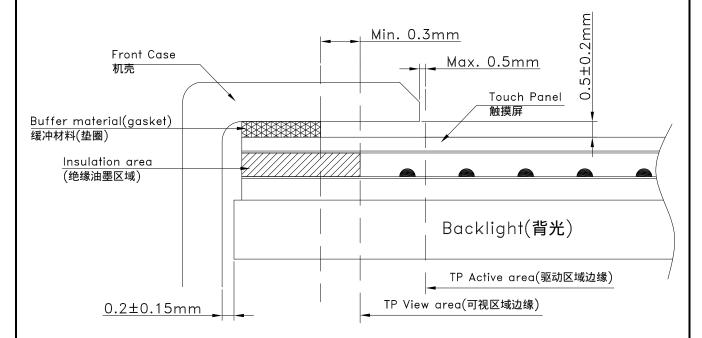
2. We recommend to design a case that it can't over the boundary of the active area Max. 0.5mm in order to prevent an operation at outside of the active area which can't guarantee the specified durability,



because operation at the outside of the active area cause serious damage of a transparent.

3. When design case for installing Module, you would consider give a distance about 0.2 ± 0.15 mm between the module edge to case inside.

4. The corners of the product are not chamfered. When positioning and fixing the product on the case, we sugguest that you would provide a R part on the conner of the case so as not to apply load on the corner of the transparent module.



10.3 Storage

1. Store in an ambient temperature of 5 to 45 °C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.

2. Storage in a clean environment, free from dust, active gas, and solvent.

3. Store in antistatic container.



11. Inspection Standard

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM with touch pannel.

11.1 Sample plan and Inspection condition

11.1.1 Sample plan

Sampling plan according to MIL-STD-105E, normal level 2 and based on:

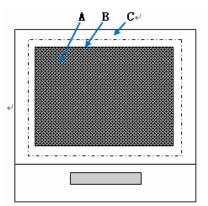
Major defect: AQL 0.65;

Minor defect: AQL 1.5.

11.1.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45 against perpendicular line.

11.2 Definition of inspection zone in LCD



Inspection zones in an LCD

Zone A: character/Digit area;

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area);

Zone C: Outside viewing area (invisible area after assembly in customer's product);

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product. Defects are classified as major defects and minor defects according to the degree of defectiveness defined herein.

11.3 Major defects and Minor defects

11.3.1 Major defects

A major defect is a defect that is likely to result in failure, or to reduce the usability of the product for its intended purpose.

11.3.1.1 Abnormal operation: modules cannot display normally;



11.3.1.2 Line defect;

11.3.1.3 There is serious distortion or sharp burr on mechanical housing;

11.3.1.4 Glass breakage.

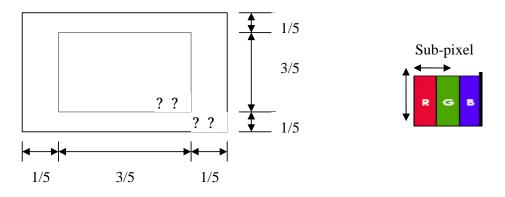
11.3.2 Minor defects:

A minor defect is a defect that is not likely to reduce the usability of the product for its intended purpose.

11.3.2.1 Dot defect:

11.3.2.1.1 Inspection pattern : Full white, full black, red, green and blue screens;

11.3.2.1.2 Criteria :(acceptable);



Note: 1. Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area . And the bright dot defect must be visible through 5% ND filter.

2. Except for the allowed numbers of adjacent dots, the distance between dot defects should be more than 3mm apart.

11.3.2.1.3 The definitions of the inner display area and outer display area.

11.4 Inspection standards table:

11.4.1 Major defect

Item No.	Items to be	Inspection Standard	Classification of defects	
11.4.1.1	All functional defects	 No display Display abnormally Missing vertical/horizontal segment Short circuit Back-light no lighting, flickering and abnormal lighting. 	Major	
11.4.1.2	Missing	Missing component		
11.4.1.3Outline dimension11.4.1.4linearity		Overall outline dimension beyond the drawing is not allowed.		
		No more than 1.5%		



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Item No	Itemsto be	Inspect	Inspection Standard					
	Clear Spot Black and white		For dark/white spot, sizeF is defined as $F = (x + y)/2$					
	Spot defect		Zone	A	cceptable Qty	,	1	
11.4.2.1	Pinhole,		ze(mm)	A B		С	1	
	Foreign	F=0.1		Ignoi	e			
	Particle,	0.10<	F=0.15	2		Ŧ	Minor	
	polarizer	0.15<	F=0.20	1		Ignore		
	Dirt	F > 0.	20	0				
			Zone		cceptable Qty	1		
		Siz	ze(mm)	A B		С		
	Clear Spot	D 0 1		Ignoi		0		
11.4.2.2	TP Dirt		F=0.15	2		Ignore	Minor	
			F=0.25	1				
		F > 0.		0				
	Dim Spots		Zone				<u> </u>	
	Circle	Siz	zone ze(mm)	A	cceptable Qty B	С		
	shaped and	F=0.2		Ignore C		C	Minor	
11.4.2.3	dim edged		F=0.4	2		Ignore		
	defects	0.4< 1		1				
		F> 0.		0				
				Ŭ]	
		uot –su	dot =sub-pixel Acceptable Qty					
				I		II		
11.4.2.4	Dot defect	De	alet dat	0			Minor	
			ight dot	0		2		
			Dark dot 1 The distance of two point >5mm		2			
11.1.0.0			•	t > 5 mm				
11.4.3 Co	smetic Defect	(linear defect	.)					
Item No	Items to be		Inspection Star	ndard			Classification of defects	
	<u> </u>						of defects	
11.4.3.1		Si	Size(mm) Acce			Acceptable Qty		
	Line defect Black line, White line, Foreign material on polarizer		W /	zone				
				ength) W(Width)		A B		
		Ignore	W=0.02	Ignore 2			Minor	
		L=3.0	0.02< W=0.03			Ignore		
		L=2.0	0.03< W=0.05					
			W> 0.05	Define as spot defect				
		L			-r st asroot	1		



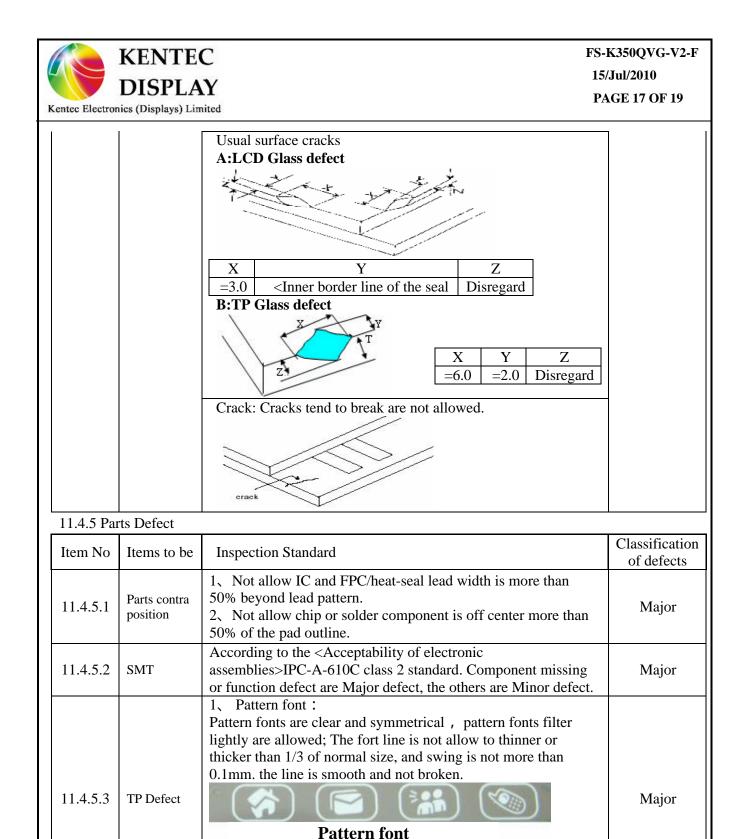
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	Foreign Material on TP film	The line can be seen after mobile phone in the operating condition:							
		Size(mm)			Acceptable Qty				
		L(Length) W(Width)		zone					
11.4.3.2					A	В	С	Minor	
		Ignore	W=0.0		Ignore				
		L=3.0		W=0.05		3	Ignore		
		XC .1 1	W> 0			spot defec			
D	Dim line	If the scratch can be seen after mobile phone cover assembling or in the operating condition, judge by the line defect of 11.4.3.1. If the scratch can be seen only in non-operating condition or some special angle, judge by the following.							
	defect	Size(mm)			1	Acceptable Qty			
11.4.3.3	Polarizer &BL scratch	L(Length) W(Width)			zone	_	Minor		
11.4.3.3	TP film	L(Length)	••(widtii)	А	В	С	winter	
	scratch	Ignore	W=0.0)2	Iş	gnore			
		L=3.0	0.02<	W=0.03		2	Ignore		
		L=2.0	0.03<	W=0.05		1	Ignore		
			W> 0	.05	Define a	s spot defea	ct		
		Air bubbles	s betwee	en glass &	polarizer				
			Acceptable Qty						
	Polarize Air bubble				А		В	С	
11.4.3.4		F=0.2			Ignore			Minor	
11.4.3.4		0.20< F=0.3			2			WIND	
		0.3< F=0.5			1		Ignore		
		F > 0.5 0							
11.4.4 Ch	ipping Defect								
Item No	Items to be		Inspec	tion Stand	lard			Classification	
Item No	Items to be	<u></u>	•	lion Stan	lalu			of defects	
		Chips on cor A:LCD Glas							
				~	~				
		$\begin{array}{c c} X & Y & Z \\ \hline \hline \\ z & \hline \\ \hline$							
	Glass defect								
11.4.4.1								Minor	
		ITO pad or expose perimeter seal. B:TP Glass defect							
		X T T							
			/	<u>↓</u>		$\begin{array}{c c} X & Y \\ \hline 3.0 & =3.0 \end{array}$	Z Disregard		
ļ	I							1	



2、The wing forward in the side of Visual Area : The length of wing forward inside of the Visual Area: n=0.2mm; Not excess 3 point, and the distance D=20mm_o



		Image: Construction of the second	
11.4.5.4	Backlight elements	 Illumination source flickers when lit. Spots or scratches that appear when lit must be judged using LCD spot, lines and contamination standards. Backlight doesn't light or color is wrong 	Major
11.4.5.5	Soldering	 1 No unmelted solder paste may be present on the FPC 2 No cold solder joints, missing solder connections, oxidation or icicle. 3 No short circuits in components on FPC 	Major



